



49/A and B (modified PTO/SB/08)

**INFORMATION DISCLOSURE
STATEMENT BY APPLICANT**

Sheet 1 of 2

APPLICATION NO.:	10/021,740	ATTY. DOCKET NO.:	M0925.70108US00
FILING DATE:	October 22, 2001	CONFIRMATION NO.:	1110
APPLICANT:	Yet-Ming Chiang et al.		
GROUP ART UNIT:	1795	EXAMINER:	J.S. Maples

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GROUP ART UNIT:	1745 1995	EXAMINER:	J.S. Maples

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EXAMINER:

DATE CONSIDERED:

10/11/07

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* A copy of this reference is not provided as it was previously cited by or submitted to the office in a prior application, Serial No. ___, filed ___, and relied upon for an earlier filing date under 35 U.S.C. 120 (continuation, continuation-in-part, and divisional applications).

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